



无蜡吸附垫 TEMPLATE

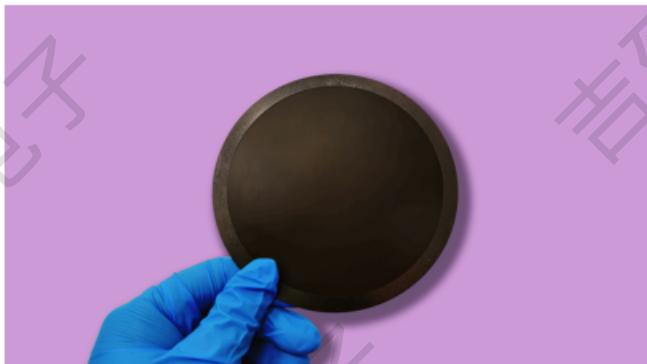
无锡吉致电子科技有限公司

About Us

WHAT MAKES US DIFFERENT ?

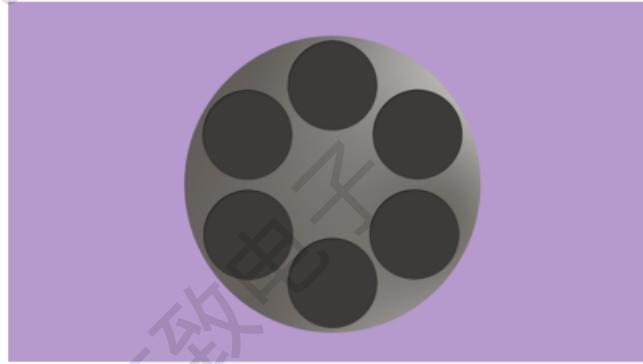
我们的产品为何与众不同：

- **吉致电子无蜡吸附垫 (Template)** 能有效节省时间和成本，消除传统工艺中蜡模装夹、拆卸及后续零件脱蜡清洁等重复性工序。
- **吉致电子** 专业定制生产适用于各类单面抛光工艺的模板组件，包括但不限于：硅晶圆、碳化硅 (SiC) 晶圆、复合衬底晶圆、玻璃晶圆、陶瓷材料，以及任何需要抛光处理的平面平行部件。
- 特别适合 **半导体、光学玻璃、精密陶瓷** 等行业，帮助客户实现 **高效、高精度** 的抛光加工需求.



无蜡吸附垫 • 特点

We have many PowerPoint templates that has been specifically designed to help anyone that is trapping into the world of PowerPoint for the very first time. We have many PowerPoint templates that has been specifically designed to help anyone that is trapping into the world of PowerPoint for the very first time.



Temolate • 结构&规格

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吉致电子·无蜡吸附垫特点

Product Features

一、定制化设计

与客户紧密合作，确保设计方案通过认证
满足物理规格要求。

二、适用于各种抛光工艺

- 翻转抛光 (Flip Polish)
- 接触抛光 (Touch Polish)
- 单面抛光 (Single-Side Polish)
- 化学机械抛光 (CMP)

三、简化工艺流程

替代传统蜡模装夹工艺 (Wax Mounting)
减少重复性操作。

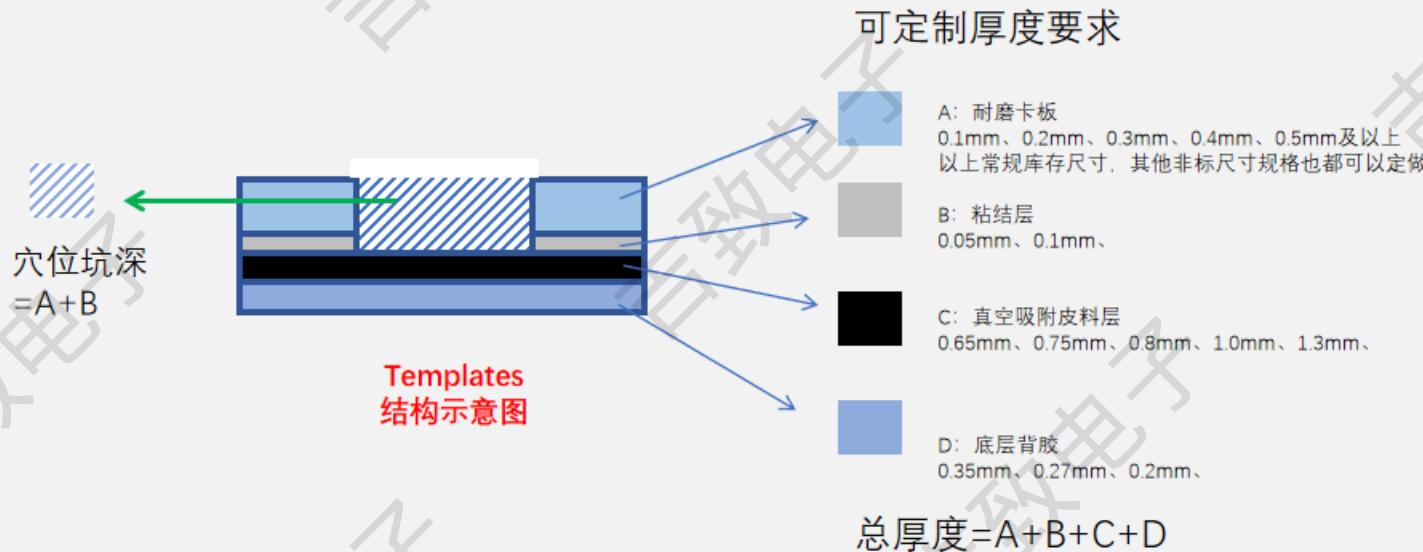
四、适用范围广泛

- 硅晶圆 (Silicon Wafers)
- 碳化硅晶圆 (SiC Wafers)
- 复合衬底晶圆 (Compound Substrate Wafers)
- 玻璃晶圆 (Glass Wafers)
- 陶瓷 (Ceramics)
- 其他需要抛光的平面平行部件



吉致电子·无蜡吸附垫结构

Structure & Specifications —

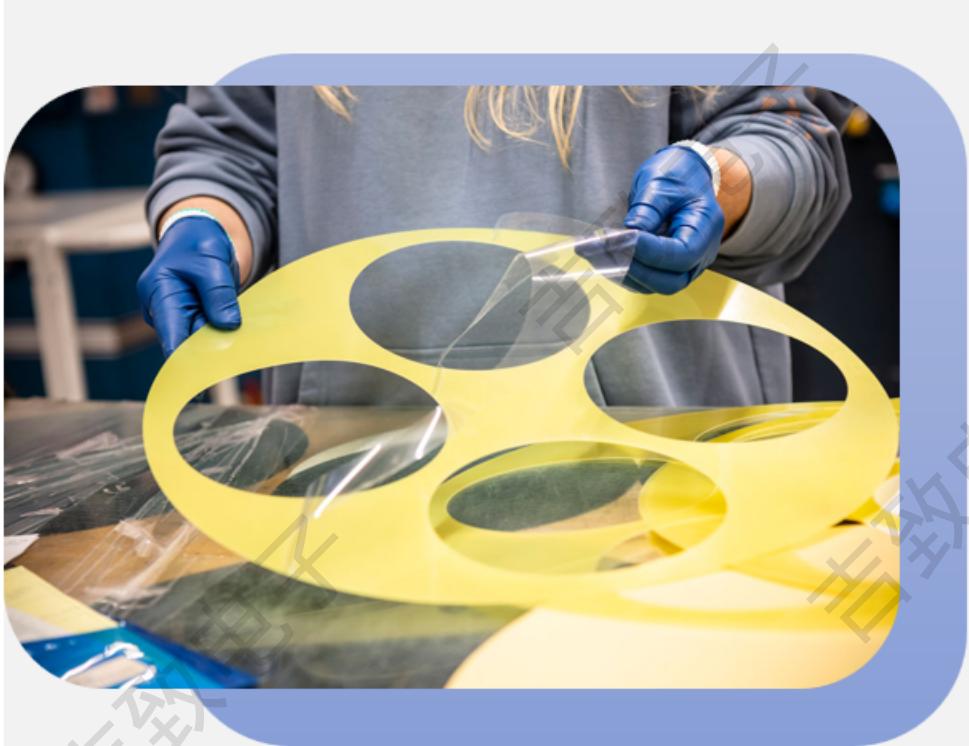


吉致电子·无蜡吸附垫规格

Structure&Specifications —

吉致电子·无蜡吸附垫规格									
项目		单位	JZ-LM065/8	JZ-LM075/23	JZ-LM08/5	JZ-LG13/35	JZ-DM08/8	JZ-DM08/21	JZ-DG11/28
厚度	Thickness	mm	0.65	0.75	0.8	1.3	0.8	0.8	1.1
密度	Density	g/cm3	0.65	0.66	0.72	0.61	0.64	0.55	0.46
压缩率	Compressibility	%	8	23	5	35	8	21	28

吉致电子可以提供客户自由选择无蜡垫搭配结构，也可以提供非标定制



吉致电子 一站式无蜡吸附垫生产厂家

- 节省时间** —— 避免反复的蜡模装夹、拆卸和清洁步骤，提高生产效率。
- 降低成本** —— 减少人工操作和材料浪费，优化整体加工成本。
- 高性能适配** —— 针对不同生产环境优化设计，确保抛光效果稳定。
- 灵活定制** —— 可根据客户需求制造适用于单面抛光工艺的专用模板组件。
- 无尘车间生产** —— 模板在干净的气候控制环境中组装，以限制粒子污染。

THANKS

Wuxi JEEZ Electronic Technology Co., Ltd